

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: Akira MATSUDA et al.

Group Art Unit: 1775

Application Number: 10/719,020

Examiner: Michael E. Lavilla

Filed: November 24, 2003

Confirmation Number: 9168

For:

PLATING BATH FOR FORMING THIN RESISTANCE LAYER, METHOD OF FORMATION OF RESISTANCE LAYER, CONDUCTIVE BASE WITH RESISTANCE LAYER, AND

CIRCUIT BOARD MATERIAL WITH RESISTANCE LAYER

Attorney Docket Number:

032130

Customer Number:

38834

<u>AMENDMENT</u>

Commissioner for Patents P. O. Box 1450 Alexandria, VA 22313-1450 August 25, 2006

Sir:

This paper is filed in response to the Office Action dated May 26, 2006.

Amendments to the Claims begin on page 2 of this paper.

Remarks begin on page 6 of this paper.